

Application Data Sheet**Application Information**

Application number::	Not Yet Assigned
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	METHOD FOR FABRICATING A SEMICONDUCTOR STRUCTURE
Attorney Docket Number::	543822002300
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Germany
Status::	Full Capacity
Given Name::	Dirk
Family Name::	EFFERENN
City of Residence::	Dresden
Country of Residence::	Germany
Street of mailing address::	Böhmische Straße 19
City of mailing address::	Dresden
Country of mailing address::	Germany
Postal or Zip Code of mailing address::	01099

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Germany
Status:: Full Capacity
Given Name:: Hans-Peter
Family Name:: MOLL
City of Residence:: Dresden
Country of Residence:: Germany
Street of mailing address:: Traubestraße 16
City of mailing address:: Dresden
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 01277

Correspondence Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Germany	10255686.5-33	November 28, 2002	Yes

Assignee Information

Assignee name:: Infineon Technologies AG
Street of mailing address:: St.-Martin Strasse 53
City of mailing address:: Munich
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 81669